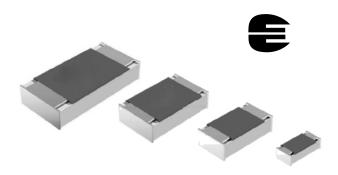


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AUTOMOTIVE

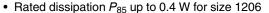
Professional Thin Film Chip Resistors Superior Moisture Resistivity



Automotive-grade MC AT professional thin film chip resistors are the perfect choice for most fields of modern professional electronics where reliability and stability is of major concern. Typical applications include automotive, telecommunication, industrial, medical equipment, precision test and measuring equipment.

FEATURES

- Operating temperature up to 175 °C for 1000 h
- Superior moisture resistivity, $|\Delta R/R|$ < 0.5 % (85 °C; 85 % RH; 1000 h)



- · AEC-Q200 qualified
- Approved according to EN 140401-801
- Lead (Pb)-free solder contacts
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- · Automotive
- Telecommunication
- · Medical equipment
- · Industrial equipment

METRIC SIZE							
INCH	0402	0603	0805	1206			
METRIC	RR 1005M	RR 1608M	RR 2012M	RR 3216M			

TECHNICAL SPECIFICATIONS								
DESCRIPTION	MCS 0402 AT	MCT 0603 AT	MCU 0805 AT	MCA 1206 AT				
Metric size	RR 1005M	RR 1608M	RR 2012M	RR 3216M				
Resistance range	47 Ω to 47 kΩ	47 Ω to 100 kΩ	47 Ω to 100 kΩ	47 Ω to 100 kΩ				
Resistance tolerance	± 1 %; ± 0.5 %							
Temperature coefficient	± 50 ppm/K; ± 25 ppm/K							
Rated dissipation P ₈₅ ⁽¹⁾	0.100 W	0.150 W	0.200 W	0.400 W				
Operating voltage, U _{max.} AC/DC	50 V	75 V	150 V	200 V				
Permissible film temperature (1)	175 °C							
Insulation voltage								
1 min; U _{ins}	75 V	100 V	200 V	300 V				
Continuous	75 V	75 V	75 V	75 V				

Note

(1) Please refer to APPLICATION INFORMATION next page.

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APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. At the maximum permissible film temperature of 175 °C the useful lifetime is specified for 1000 h. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION							
Operation mode	Standard	Power	Advanced Temperature				
Rated dissipation	P ₇₀	P ₇₀	P ₈₅				
MCS 0402 AT	0.063 W	0.100 W	0.100 W				
MCT 0603 AT	0.100 W	0.125 W	0.150 W				
MCU 0805 AT	0.125 W	0.200 W	0.200 W				
MCA 1206 AT	0.250 W	0.400 W	0.400 W				
Film temperature	125 °C	155 °C	175 °C				
Max. resistance change at rated dissipation for resistance range:							
MCS 0402 AT	47 Ω to 47 k Ω	47 Ω to 47 k Ω	47 Ω to 47 k Ω				
MCT 0603 AT	47 Ω to 100 k Ω	47 Ω to 100 k Ω	47 Ω to 100 k Ω				
MCU 0805 AT	47 Ω to 100 k Ω	47 Ω to 100 k Ω	47 Ω to 100 k Ω				
MCA 1206 AT	47 Ω to 100 k Ω	47 Ω to 100 k Ω	47 Ω to 100 k Ω				
$ \Delta R/R $ max., after:							
1000 h	≤ 0.15 %	≤ 0.3 %	≤ 0.5 %				
8000 h	≤ 0.25 %	≤ 0.5 %	-				
225 000 h	≤ 1.0 %	-	-				

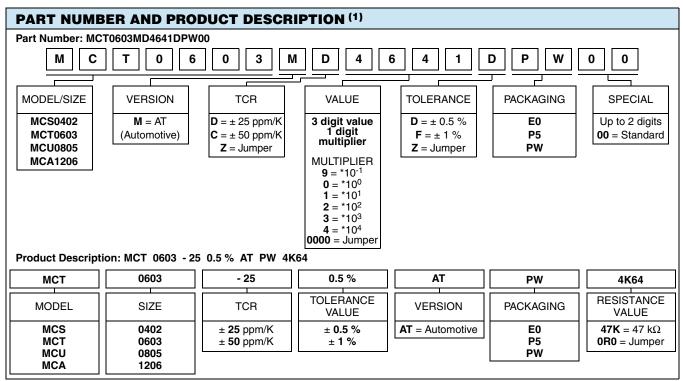
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Note

⁽¹⁾ Products can be ordered using either the PART NUMBER and PRODUCT DESCRIPTION.

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE							
DESCRIPTION		RESISTANCE VALUE (2)					
TCR	TOLERANCE	MCS 0402 AT	MCS 0402 AT MCT 0603 AT MCU 0805 AT MCA 1206 A				
. 50 ppm/K	± 1 %						
± 50 ppm/K	± 0.5 %	47 Ω to 47 k Ω	47 Ω to 100 $k\Omega$	47 Ω to 100 k Ω	47 Ω to 100 $k\Omega$		
± 25 ppm/K	± 0.5 %						
Jumper	-	\leq 20 m Ω ; $I_{\text{max.}} = 0.63 \text{ A}$	\leq 20 m Ω ; $I_{\text{max.}} = 1 \text{ A}$	\leq 20 mΩ; $I_{max.}$ = 1.5 A	\leq 20 m Ω ; $I_{\text{max.}} = 2 \text{ A}$		

Note

 $^{^{(2)}}$ Resistance values to be selected for \pm 1 % tolerance from E24 and E96; for \pm 0.5 % tolerance from E24 and E192.

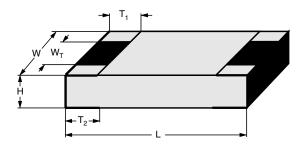
PACKAGING						
	REEL					
MODEL	PIECES/ PAPER TAPE ON REEL	CODE				
MCS 0402 AT	10 000	E0				
MCT 0603 AT	5000	P5				
WICT 0003 AT	20 000	PW				
MCU 0805 AT	5000	P5				
WICO 0605 AT	20 000	PW				
MCA 1206 AT	5000	P5				

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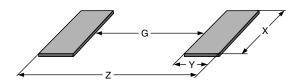


DIMENSIONS



DIMENSIO	DIMENSIONS AND MASS							
TYPE	H (mm)	L (mm)	W (mm)	W _T (mm)	T ₁ (mm)	T ₂ (mm)	MASS (mg)	
MCS 0402 AT	0.32 ± 0.05	1.0 ± 0.05	0.5 ± 0.05	> 75 % of W	0.2 + 0.1/- 0.15	0.2 ± 0.1	0.6	
MCT 0603 AT	0.45 + 0.1/- 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15/- 0.2	0.3 + 0.15/- 0.2	1.9	
MCU 0805 AT	0.52 ± 0.1	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 + 0.1/- 0.2	0.4 + 0.1/- 0.2	4.6	
MCA 1206 AT	0.55 ± 0.1	3.2 + 0.1/- 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.2	

SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS								
		WAVE SOLDERING			REFLOW SOLDERING			
TYPE	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
MCS 0402 AT	=	-	-	-	0.35	0.55	0.55	1.45
MCT 0603 AT	0.55	1.10	1.10	2.75	0.65	0.70	0.95	2.05
MCU 0805 AT	0.80	1.25	1.50	3.30	0.90	0.90	1.40	2.70
MCA 1206 AT	1.40	1.50	1.90	4.40	1.50	1.15	1.75	3.80

Note

• The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or boardmaterials may be required to maintain the reliability of the assembly. Specified power rating above 125 °C requires dedicated heat-sink pads, which depend on boardmaterials.

The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.

Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to "standard operation mode". Please note however that applications for "power operation mode" or "advanced temperature mode" require special considerations for the design of solder pads and adjacent conductor areas.



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DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of special metal alloy is deposited on a high grade (Al₂O₃) ceramic substrate and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly cutting a meander groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a unique protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3** ⁽³⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in **IEC 61760-1** ⁽³⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS compliant; the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the **GADSL** ⁽¹⁾ and the **CEFIC-EECA-EICTA** ⁽²⁾ list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle life Directive (ELV) and Annex II (ELV II)
- 2002/95/EC Restriction of the use of Hazardous Substances directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

APPROVALS

The resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-801** which refers to **EN 60115-1**, **EN 140400** and the variety of environmental test procedures of the IEC 60068 ⁽³⁾ series. The detail specification refers to the climatic category 55/125/56, which relates to the "standard operation mode" of this datasheet.

Conformity is attested by the use of the **CECC** logo (as the mark of conformity on the package label. For MCS 0402 AT and zero ohm jumpers the certification according to DIN EN 140401-801:2008-05 is pending.

Vishay BEYSCHLAG has achieved "Approval of Manufacturer" in accordance with IEC QC 001002-3, clause 2. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IEC QC 001002-3, clause 6 is granted for the Vishay BEYSCHLAG manufacturing process.

The resistors are qualified according to AEC-Q200.

RELATED PRODUCTS

This product family of thin film flat chip resistors is completed by **Zero Ohm Jumpers**.

For more information about products with better TCR and tighter tolerance please refer to the **precision** datasheet document no. **28785**.

Chip resistor arrays may be used in sensing applications or precision amplifiers where close matching between multiple resistors is necessary. Please refer to the ACAS AT - Precision datasheet document no. 28770.

Notes

(1) Global Automotive Declarable Substance List, see www.gadsl.org.

(3) The quoted IEC standards are also released as EN standards with the same number and identical contents.

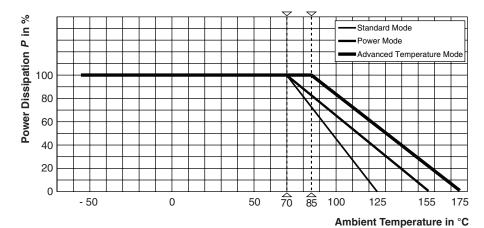
⁽²⁾ CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see www.eicta.org/index.php?id=995 → issues → environment policy → chemicals → chemicals for electronics.

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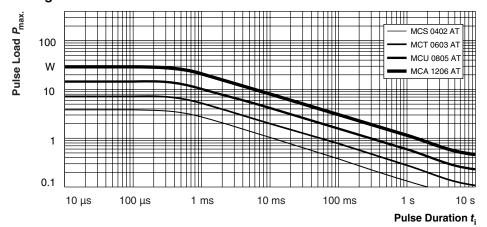


FUNCTIONAL PERFORMANCE



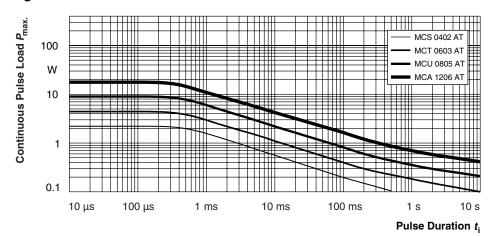
For permissible resistance change please refer to table MAXIMUM RESISTANCE CHANGE AT RATED POWER, above

Derating



Maximum pulse load, single pulse; for permissible resistance change equivalent to 8000 h operation

Single Pulse



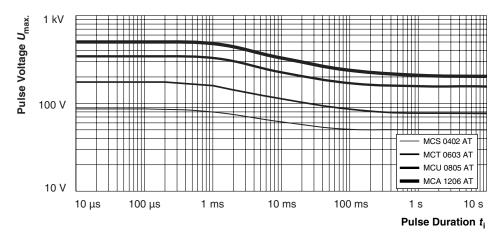
Maximum pulse load, continuous pulses; for permissible resistance change equivalent to 8000 h operation

Continuous Pulse

274

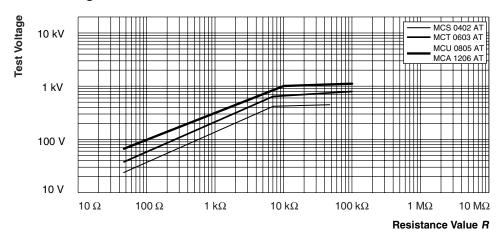
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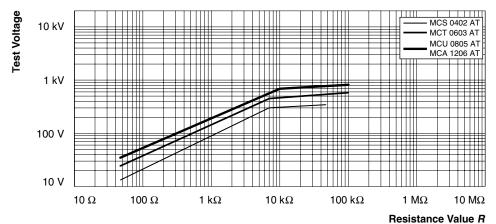
Maximum pulse voltage, single and continuous pulses; for permissible resistance change equivalent to 8000 h operation

Pulse Voltage



Pulse load rating in accordance with EN 60115-1 clause 4.27; 1.2 μ s/50 μ s; 5 pulses at 12 s interval; for permissible resistance change 0.5 %

1.2/50 Pulse



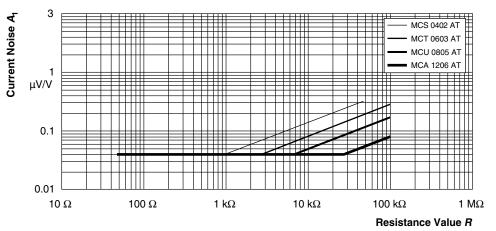
Pulse load rating in accordance with EN 60115-1 clause 4.27; 10 μ s/700 μ s; 10 pulses at 1 min intervals; for permissible resistance change 0.5 %

10/700 Pulse

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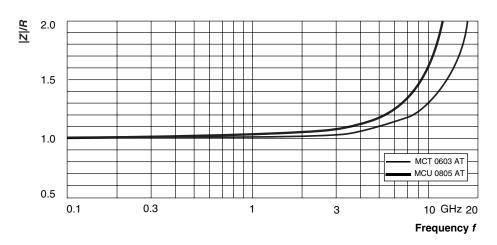
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Current noise A₁ in accordance with IEC 60195

Current Noise



|Z|/R for 49.9 Ω chip resistor

RF-Behaviour

TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 140400, sectional specification

EN 140401-801, detail specification

The components are approved in accordance with the IECQ-CECC-system, where applicable. The following table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068 and under standard atmospheric conditions in accordance with IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower category temperature, upper

category temperature; damp heat, long term, 56 days) is valid (LCT = -55 °C/UCT = 155 °C).

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on boards in accordance with EN 140400, 2.3.3 unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. However, some additional tests and a number of improvements against those minimum requirements have been included.



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	IEC	RES AND REQUIREM		REQUIREMENTS
EN 60115-1	60068-2 TEST	TEST	PROCEDURE	PERMISSIBLE CHANGE (△R)
CLAUSE	METHOD			STABILITY CLASS 0.5 OR BETTER
	1		Stability for product types:	
			MCS 0402 AT	47 Ω to 47 k Ω
			MCT 0603 AT	47 Ω to 100 kΩ
			MCU 0805 AT	47 Ω to 100 kΩ
	†		MCA 1206 AT	47 Ω to 100 kΩ
4.5	-	Resistance		± 1 % R; ± 0.5 % R
4.8.4.2	-	Temperature coefficient	At (20/- 55/20) °C and (20/155/20) °C	± 50 ppm/K; ± 25 ppm/K
		Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	± (0.15 % R + 0.05 Ω) ± (0.25 % R + 0.05 Ω)
4.25.1	-	Endurance at 70 °C: Power operation mode	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ whichever is the less severe; $1.5 \text{ h on; } 0.5 \text{ h off;}$ $70 \text{ °C; } 1000 \text{ h}$ $70 \text{ °C; } 8000 \text{ h}$	\pm (0.3 % R + 0.05 Ω) \pm (0.5 % R + 0.05 Ω)
		Endurance at 85 °C: Advanced temperature operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$; whichever is the less severe; 1.5 h on; 0.5 h off; 85 °C; 1000 h	± (0.5 % R + 0.05 Ω)
4.25.3	-	Endurance at upper category temperature	125 °C; 1000 h 155 °C; 1000 h 175 °C; 1000 h	\pm (0.15 % R + 0.05 Ω) \pm (0.3 % R + 0.05 Ω) \pm (0.5 % R + 0.05 Ω)
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (0.1 % R + 0.05 Ω)
4.39	67 (Cy)	Damp heat, steady state, accelerated	$(85 \pm 2) ^{\circ}C$ $(85 \pm 5) ^{\circ} RH$ $U = 0.1 \times \sqrt{P_{70}} \times R$ $\leq 100 \text{ V'};$ 1000 h	± (0.5 % R + 0.05 Ω)
4.23		Climatic sequence:		
4.23.2	2 (Ba)	Dry heat	155 °C; 16 h	
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 1 cycle	
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	$\pm (0.5 \% R + 0.05 \Omega)$
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 ± 10) °C	
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 5 days > 90 % RH; 5 cycles	
4.23.7	_	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}; \text{ 1 min}$	
-	1 (Aa)	Storage at low temperature	- 55 °C; 2 h	± (0.1 % R + 0.01 Ω)
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 °C and 30 min at 155 °C; 1000 cycles	± (0.25 % R + 0.05 Ω)
4.13	_	Short time overload; standard operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$	± (0.1 % R + 0.01 Ω)
T. 10	-	Short time overload; power operation mode	$\leq 2 \times U_{\text{max}}$; 5 s	± (0.25 % R + 0.05 Ω)

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	IEC			REQUIREMENTS
EN 60115-1	60068-2	TEST	PROCEDURE	PERMISSIBLE CHANGE (△R)
CLAUSE	TEST METHOD			STABILITY CLASS 0.5 OR BETTER
			Stability for product types:	
			MCS 0402 AT	47 Ω to 47 kΩ
			MCT 0603 AT	47 Ω to 100 kΩ
			MCU 0805 AT	47 Ω to 100 kΩ
			MCA 1206 AT	47 Ω to 100 kΩ
4.07		Single pulse high voltage overload; standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$	± (0.25 % R + 0.05 Ω)
4.27	-	Single pulse high voltage overload; power operation mode	≤2 x $\widetilde{U}_{\text{max.}}$; 10 pulses	± (0.5 % R + 0.05 Ω)
4.37		Periodic electric overload; standard operation mode	$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{\text{max.}};$	± (0.5 % R + 0.05 Ω)
4.37	-	Periodic electric overload; power operation mode	0.1 s on; 2.5 s off; 1000 cycles	± (1.0 % R + 0.05 Ω)
4.40	-	ESD (Electro Static Discharge)	IEC 61340-3-1; 3 pos. + 3 neg. (equivalent to MIL-STD-883, Method 3015) MCS 0402 AT: 500 V MCT 0603 AT: 1000 V MCU 0805 AT: 1500 V MCA 1206 AT: 2000 V	± (0.5 % R + 0.05 Ω)
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s²; 6 h	\pm (0.1 % R + 0.01 Ω) no visible damage
			Solder bath method; SnPb40; non-activated flux (215 ± 3) °C; (3 ± 0.3) s	Good tinning (≥ 95 % covered); no visible damage
4.17.2	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 ± 3) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered); no visible damage
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s	\pm (0.1 % R + 0.01 Ω) no visible damage
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol + 50 °C; method 2	No visible damage
4.32	21 (Ue ₃)	Shear (adhesion)	RR 1005M and RR 1608M; 9 N	No visible damage
T.UZ	21 (063)	Shear (aunesion)	RR 2012M and RR 3216M; 45 N	ino visible dalliage
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	$\begin{array}{c} \pm \; (0.1 \; \% \; R + 0.01 \; \Omega) \\ \text{no visible damage; no open circuit in bent posit} \end{array}$
4.7	-	Voltage proof	$U_{\rm RMS} = U_{\rm ins}; (60 \pm 5) {\rm s}$	No flashover or breakdown
4.35	-	Flammability	Needle flame test; 10 s	No burning after 30 s

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